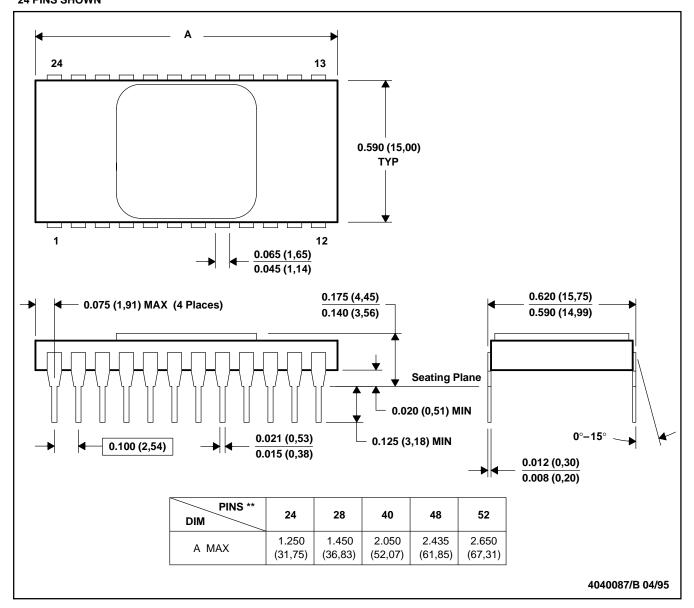
JD (R-CDIP-T**)

24 PINS SHOWN

CERAMIC SIDE-BRAZE DUAL-IN-LINE PACKAGE



NOTES: A. All linear dimensions are in inches (millimeters).

- B. This drawing is subject to change without notice.
- C. This package is hermetically sealed with a metal lid.
- D. The terminals are gold-plated.

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